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Enclosed for filing is a patent application under 37 CFR 1.53(b) of:

Inventor:

Jong-Joo LEE and Dong-Ho LEE

For:

MULTI-CHIP BALL GRID ARRAY PACKAGE

Applicant requests FIG. 2 to be published with the application.

Enclosures:

\boxtimes	Specification (pages 1-31); claim	s (pages 32-36); abstract (page 37)				
\boxtimes	TWENTY sheet(s) of FORMAL	drawings				
	Declaration or Combined Declara	ation and Power of Attorney (unsigned)				
	Assignment with cover sheet					
	Assignee Name and Address:	Samsung Electronics Co., Ltd.				
	_	Suwon-city, Kyungki-do, Republic of Korea				
abla	D -4 D4					

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CLAIMS AS FILED								
For	Number Filed	Number Extra	Rate	Basic Fee \$770				
Total Claims	36-20	16	x \$ 18 =	\$288				
Independent Claims	3-3	0	x \$ 86 =	0				
TOTAL FILING FEE				\$1058				

Certified copy of Priority Document No. 2003-26581, filed April 26, 2003

Information Disclosure Statement with Form PTO 1449

Copies of references listed on attached Form PTO-1449

PTO Form 2038 authorizing credit card payment for the above-listed fees is enclosed.

Any deficiency or overpayment should be charged or credited to deposit account number 13-1703. A duplicate copy of this sheet is enclosed.

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Respectfully submitted,

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